

4 PIN SOP, 1.0 Ω LOW ON-STATE RESISTANCE 1-CH OPTICAL COUPLED MOSFET

PS7214-1A

FEATURES

- **LOW ON-STATE RESISTANCE:**
 $R_{ON} = 1.0 \Omega$ TYP
- **LARGE CONTINUOUS LOAD CURRENT:**
 $I_L = 400$ mA
- **1 CHANNEL TYPE:**
1a output
- **DESIGNED FOR AC/DC SWITCHING LINE CHANGER**
- **SMALL AND THIN PACKAGE:**
4 pin SOP, Height = 2.1 mm
- **HIGH ISOLATION VOLTAGE:**
($BV = 1500$ Vr.m.s.)
- **LOW OFFSET VOLTAGE**
- **SURFACE MOUNT TYPE LEAD:**
PS7214-1A-E3, E4, F3, F4

DESCRIPTION

The PS7214-1A is a low on-state resistance solid state relay containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

It is suitable for PLC, etc. because of its large continuous load current and low on-state resistance.

APPLICATIONS

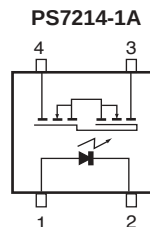
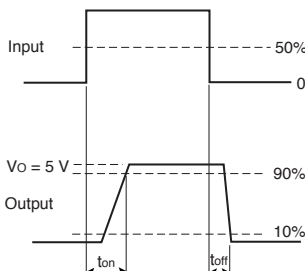
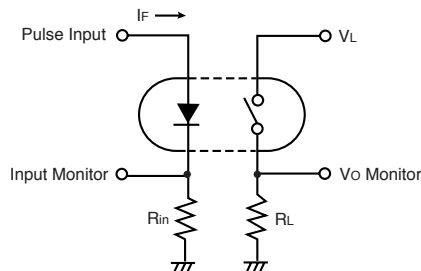
- MEASUREMENT EQUIPMENT
- FA EQUIPMENT

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

PART NUMBER				PS7214-1A		
SYMBOLS		PARAMETERS	UNITS	MIN	TYP	MAX
Diode	V_F	Forward Voltage, $I_F = 10$ mA	V		1.2	1.4
	I_R	Reverse Current, $V_R = 5$ V	μA			5.0
MOS FET	I_{OFF}	Off-State Leakage Current, $V_D = 100$ V	μA			1.0
	C_{OUT}	Output Capacitance, $V_D = 0$ V, $f = 1$ MHz	pF		120	
Coupled	I_{Fon}	LED On-State Current, $I_L = 400$ mA	mA			2.0
	R_{on}	On-state Resistance, $I_F = 10$ mA, $I_L = 400$ mA, $t_s \leq 10$ ms	Ω		1.0	1.2
	t_{ON}	Turn-on Time ¹ , $I_F = 10$ mA, $V_O = 5$ V, $R_L = 500 \Omega$, $PW \geq 10$ ms	ms		1.3	2.0
	t_{OFF}	Turn-off Time ¹ , $I_F = 10$ mA, $V_O = 5$ V, $R_L = 500 \Omega$, $PW \geq 10$ ms	ms		0.1	1.0
	R_{I-O}	Isolation Resistance, $V_{I-O} = 1.0$ kVDC	Ω	10^9		
	C_{I-O}	Isolation Capacitance, $V = 0$ V, $f = 1$ MHz	pF		0.5	

Note:

1. Test circuit for Switching Time:



PS7214-1A

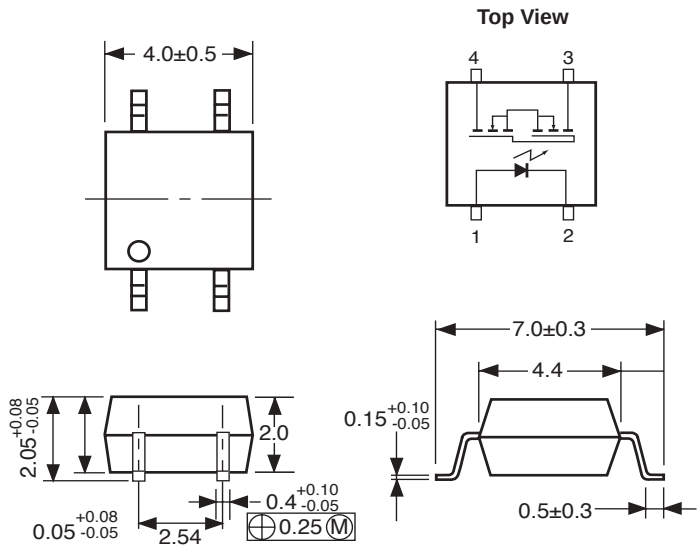
ABSOLUTE MAXIMUM RATINGS¹ (T_A = 25°C)

SYMBOLS	PARAMETERS	UNITS	RATINGS
Diode			
I _F	Forward Current (DC)	mA	50
V _R	Reverse Voltage	V	5.0
P _D	Power Dissipation	mW	50
I _{FP}	Peak Foward Current ²	A	1
MOSFET			
V _L	Break Down Voltage	V	100
I _L	Continuous Load Current	mA	400
I _{LP}	Pulse Load Current ³ (AC/DC Connection)	A	0.8
P _D	Power Dissipation	mW	300
Coupled			
BV	Isolation Voltage ⁴	Vr.m.s.	1500
P _T	Total Power Dissipation	mW	350
T _A	Operating Ambient Temp.	°C	-40 to +85
T _{STG}	Storage Temperature	°C	-40 to +100

Notes:

1. Operation in excess of any one of these parameters may result in permanent damage.
2. PW = 100 μs, Duty Cycle = 1 %
3. PW = 100 ms, 1 shot
4. AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output.

OUTLINE DIMENSIONS (Units in mm)



RECOMMENDED
OPERATING CONDITIONS (T_A = 25°C)

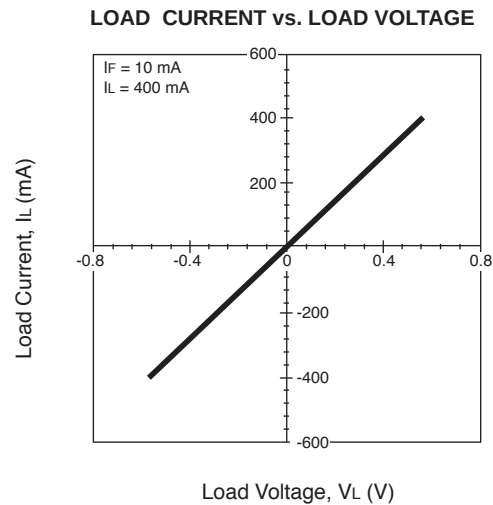
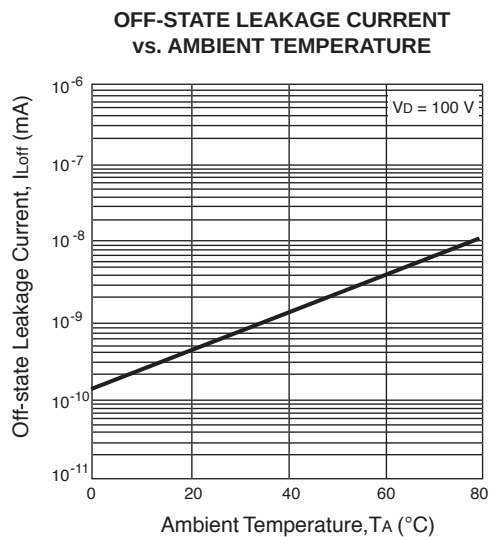
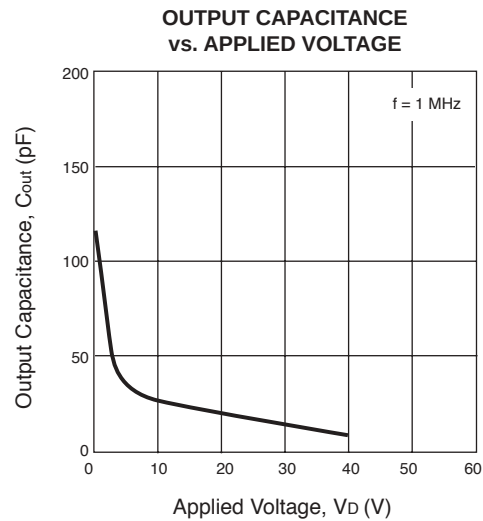
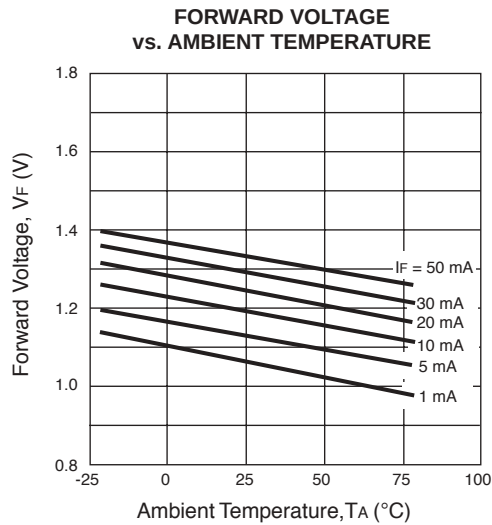
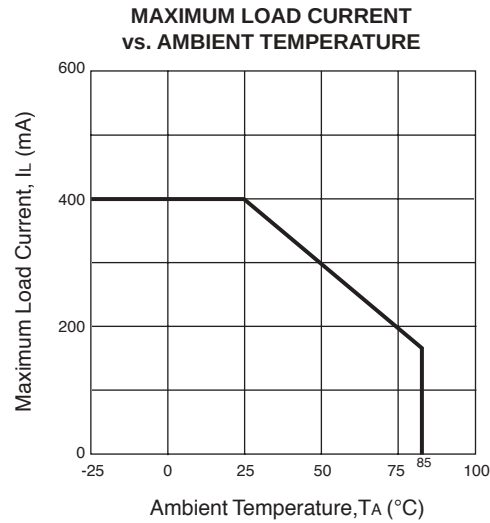
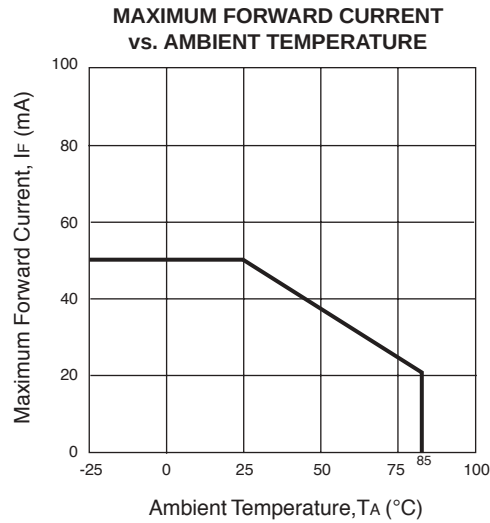
PART NUMBER		PS7214-1A			
SYMBOLS	PARAMETERS	UNITS	MIN	TYP	MAX
I _F	LED Operating Current	mA	2	10	20
V _F	LED Off Voltage	V	0		0.5

ORDERING INFORMATION

PART NUMBER	PACKING STYLE
PS7214-1A	Magazine case 100 pcs
PS7214-1A-E3	Embossed tape 900 pcs/reel
PS7214-1A-E4	
PS7214-1A-F3	Embossed tape 3500 pcs/reel
PS7214-1A-F4	

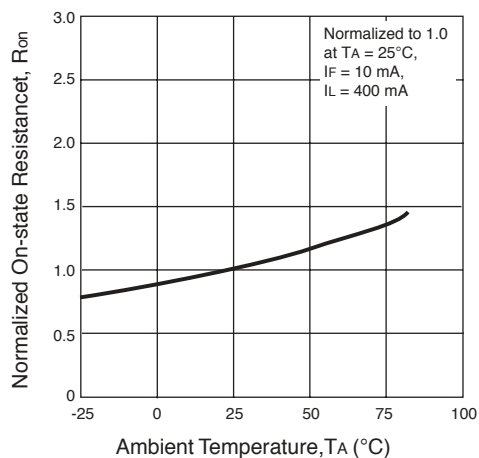
- 1. LED Anode
- 2. LED Cathode
- 3. MOS FET
- 4. MOS FET

TYPICAL PERFORMANCE CURVES (T_A = 25°C)

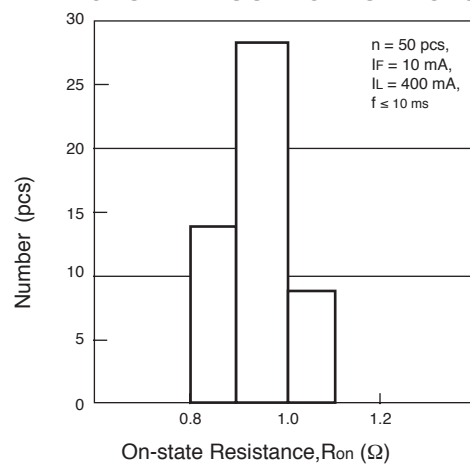


TYPICAL PERFORMANCE CURVES (TA = 25°C)

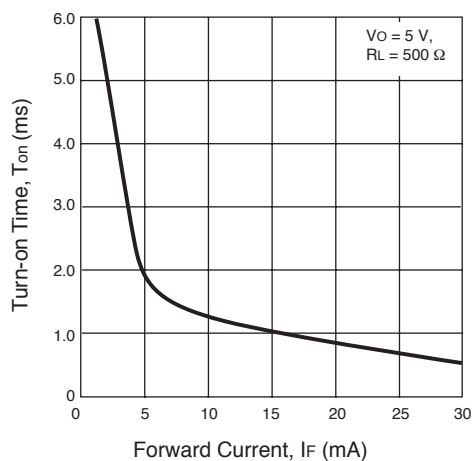
NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



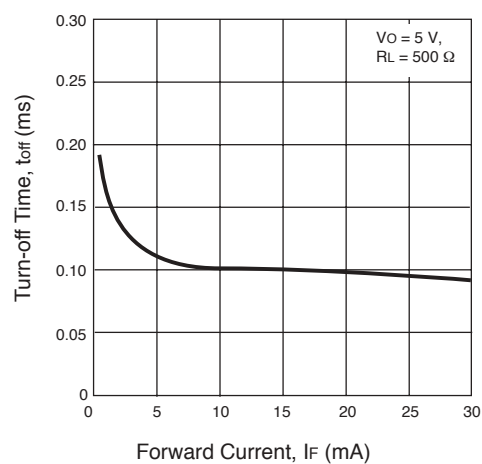
ON-STATE RESISTANCE DISTRIBUTION



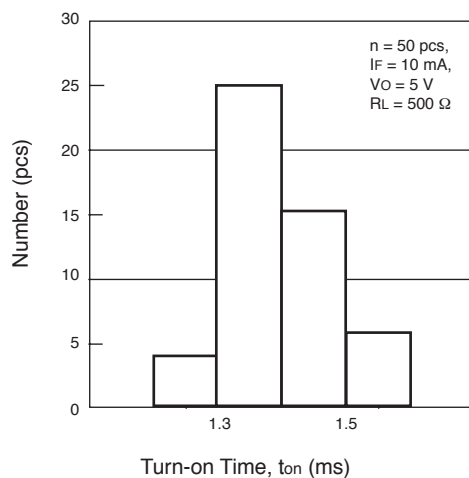
TURN-ON TIME vs. FORWARD CURRENT



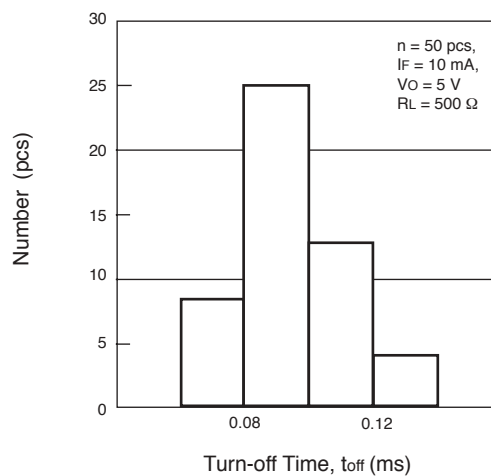
TURN-OFF TIME vs. FORWARD CURRENT



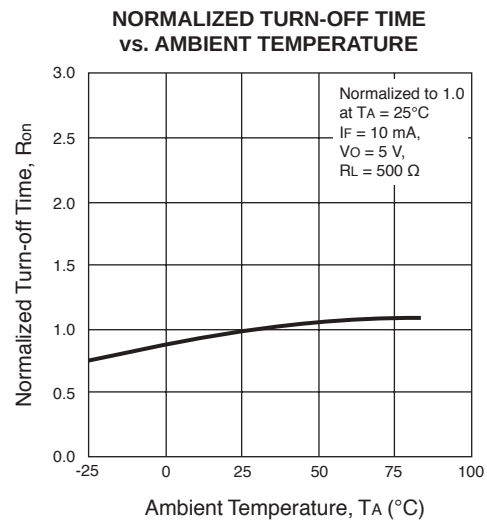
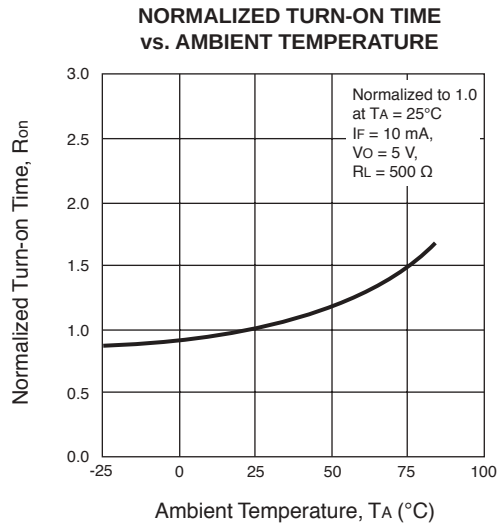
TURN-ON TIME DISTRIBUTION



TURN-OFF TIME DISTRIBUTION



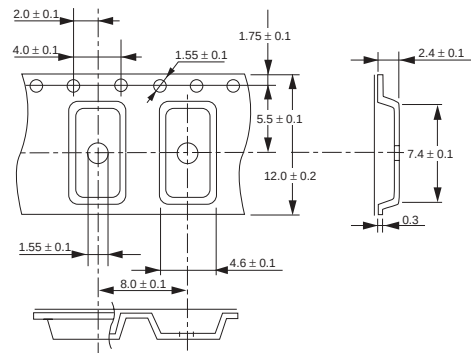
TYPICAL PERFORMANCE CURVES (TA= 25°C)



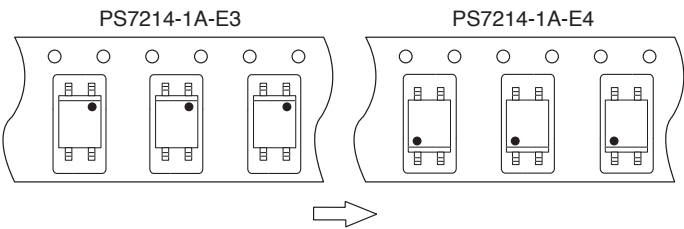
Remark: The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS

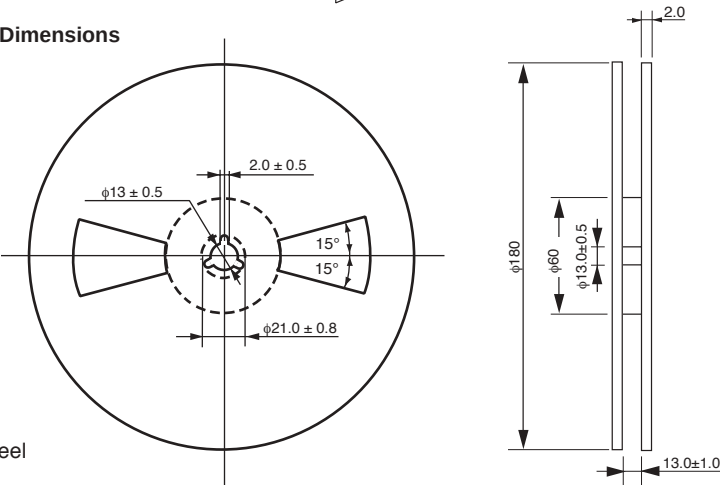
Tape Outline and Dimensions



Tape Direction



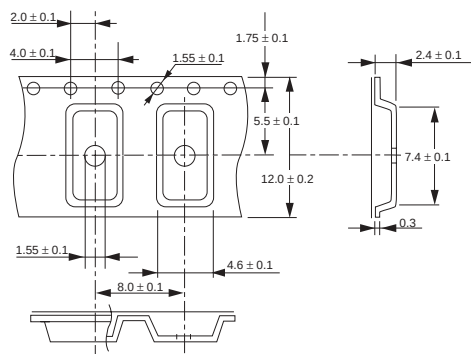
Reel Outline and Dimensions



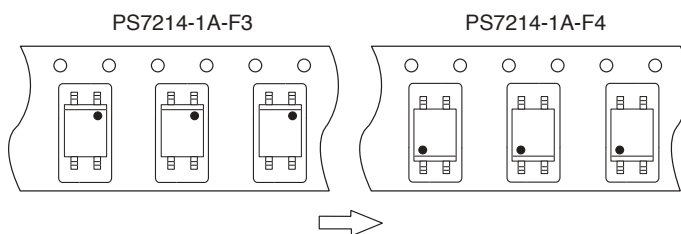
Packing: 900 pcs/reel

TAPING SPECIFICATIONS

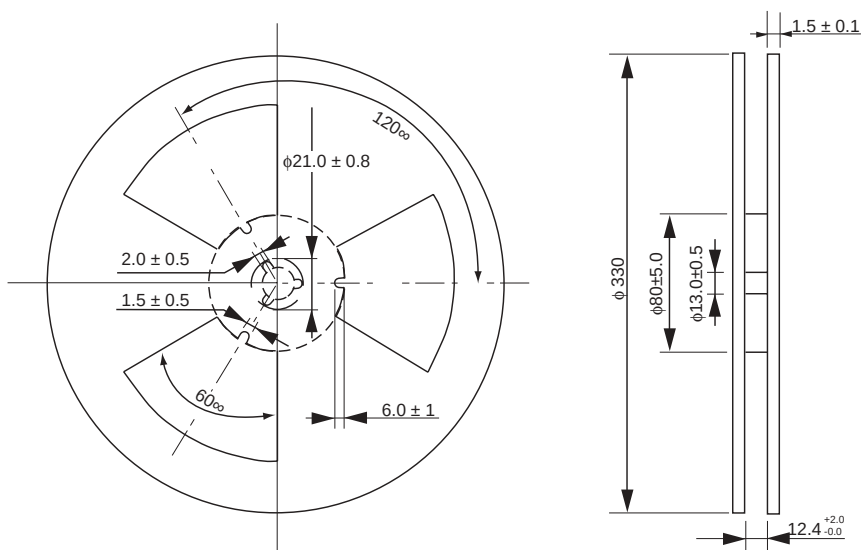
Tape Outline and Dimensions



Tape Direction



Reel Outline and Dimensions

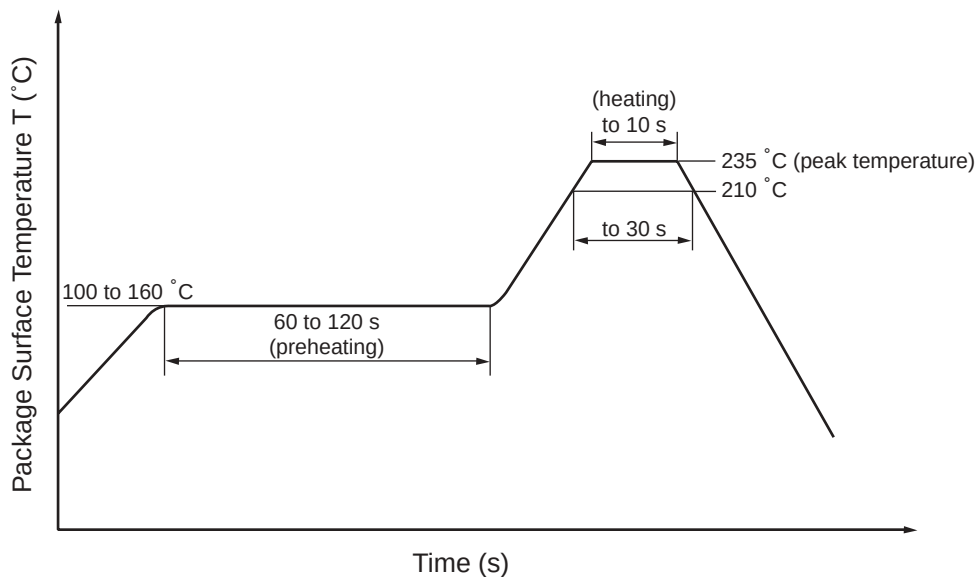


Packing: 3500 pcs/reel

RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

- Peak reflow temperature 235 °C or below (package surface temperature)
- Time of temperature higher than 210 °C 30 seconds or less
- Number of reflows Two
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)



(2) Dip soldering

- Temperature 260° or below (package surface temperature)
- Time 10 seconds or less
- Number of times One
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended).

(3) Cautions

- Fluxes Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

Life Support Applications

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